

# General Purpose Transistors

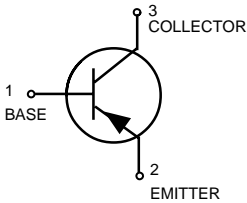
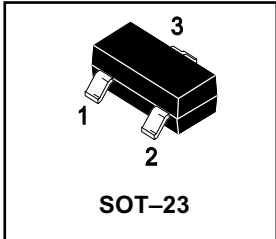
## 2SA812Q Series S-2SA812Q Series

### FEATURE

- High Voltage:  $V_{CEO} = -50\text{ V}$ .
- Epitaxial planar type.
- NPN complement: 2SC1623
- We declare that the material of product compliance with RoHS requirements.
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

### DEVICE MARKING AND ORDERING INFORMATION

Device	Marking	Shipping
2SA812Q S-2SA812Q	M8	3000/Tape&Reel
2SA812R S-2SA812R	M6	3000/Tape&Reel
2SA812S S-2SA812S	M7	3000/Tape&Reel



### MAXIMUM RATINGS

Rating	Symbol	L2SA812	Unit
Collector-Emitter Voltage	$V_{CEO}$	-50	V
Collector-Base Voltage	$V_{CBO}$	-60	V
Emitter-Base Voltage	$V_{EBO}$	-6	V
Collector current-continuoun	$I_c$	-150	mAdc

### THERMAL CHARATEERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (1) $T_A=25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	200 1.8	mW mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	556	°C/W
Total Device Dissipation Alumina Substrate, (2) $T_A=25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	200 2.4	mW mW/°C
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	417	°C/W
Junction and Storage Temperature	$T_J, T_{stg}$	-55 to +150	°C



**ELECTRICAL CHARACTERISTICS (TA=25°C unless otherwise noted)**

Characteristic	Symbol	Min	Typ	Max	Unit
----------------	--------	-----	-----	-----	------

**OFF CHARACTERISTICS**

Collector-Emitter Breakdown Voltage (IC=-1mA)	V <sub>(BR)CEO</sub>	-50	-	-	V
Emitter-Base Breakdown Voltage (IE=-50 μA )	V <sub>(BR)EBO</sub>	-6	-	-	V
Collector-Base Breakdown Voltage (IC=-50 μA)	V <sub>(BR)CBO</sub>	-60	-	-	V
Collector Cutoff Current (V <sub>CB</sub> =-50V)	I <sub>CBO</sub>	-	-	-0.1	μA
Emitter Cutoff Current (V <sub>BE</sub> =-6V)	I <sub>EBO</sub>	-	-	-0.1	μA

**ON CHARACTERISTICS**

DC Current Gain (IC=-1mA, V <sub>CE</sub> =-6.0V)	h <sub>FE</sub>	120	-	560	
Collector-Emitter Saturation Voltage (IC=-100mA, I <sub>B</sub> =-10mA)	V <sub>CE(sat)</sub>	-	-0.18	-0.3	V
Base -Emitter On Voltage I <sub>E</sub> =-1.0mA, V <sub>CE</sub> =-6.0V)	V <sub>BE</sub>	-0.58	-0.62	-0.68	V

**SMALL-SIGNAL CHARACTERISTICS**

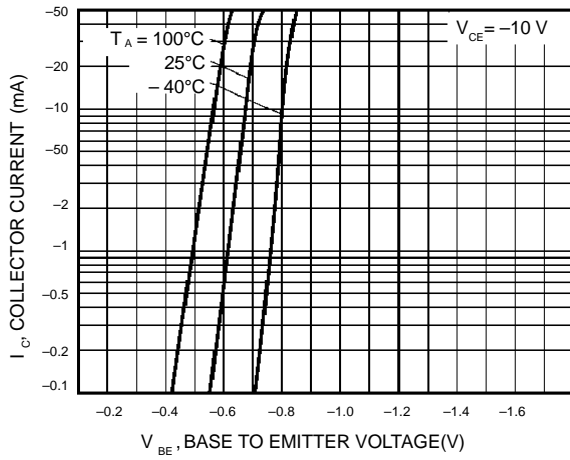
Current-Gain-Bandwidth Product (V <sub>CE</sub> =-6.0V, I <sub>E</sub> =-10mA)	F <sub>t</sub>	-	180	-	MHz
Output Capacitance(V <sub>CE</sub> = -10V, I <sub>E</sub> =0, f=1.0MHz)	C <sub>obo</sub>	-	4.5	-	pF

**h<sub>FE</sub> Values are classified as follows**

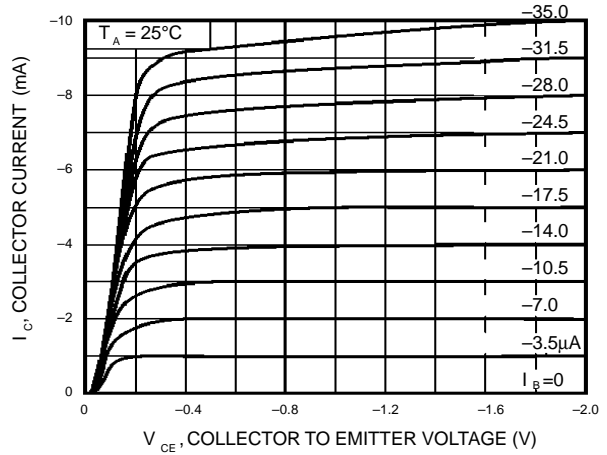
NOTE:	*	Q	R	S
	h <sub>FE</sub>	120~270	180~390	270~560



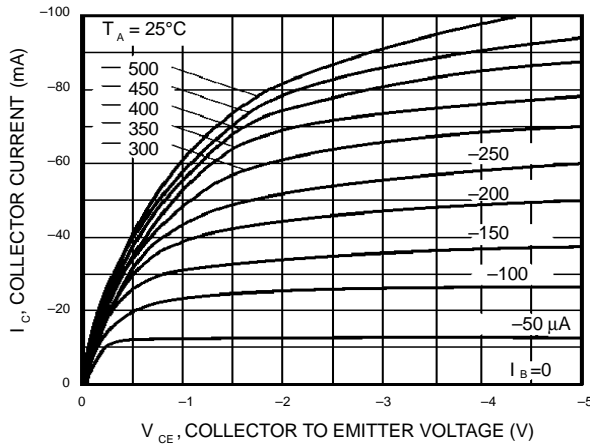
**Fig.1 Grounded emitter propagation characteristics**



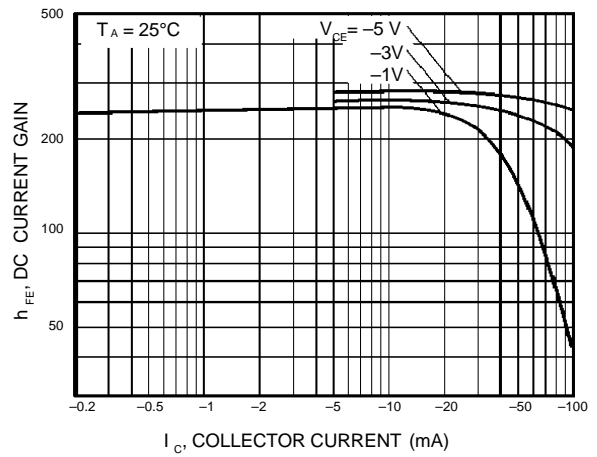
**Fig.2 Grounded emitter output characteristics(I)**



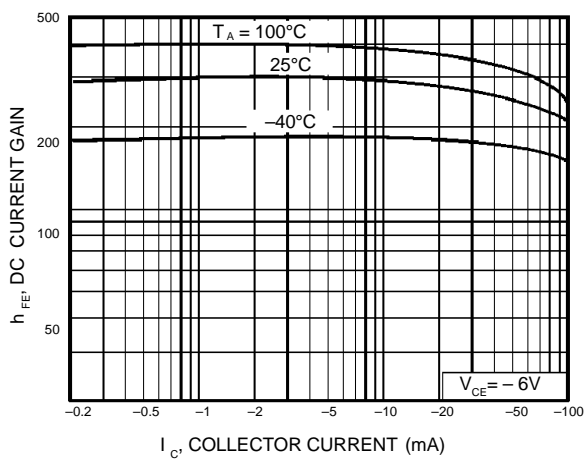
**Fig.3 Grounded emitter output characteristics(II)**



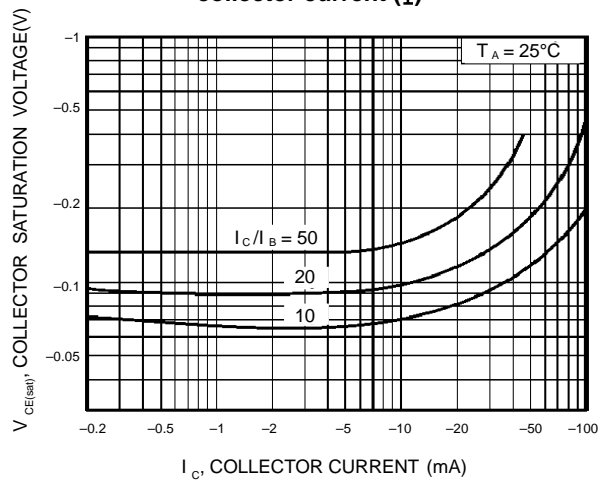
**Fig.4 DC current gain vs. collector current (I)**



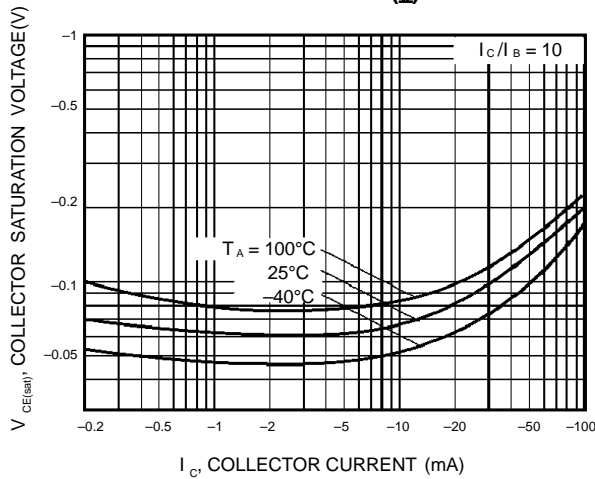
**Fig.5 DC current gain vs. collector current (II)**



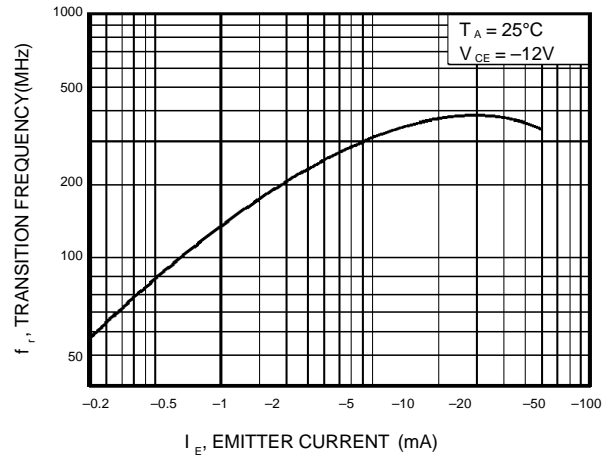
**Fig.6 Collector-emitter saturation voltage vs. collector current (I)**



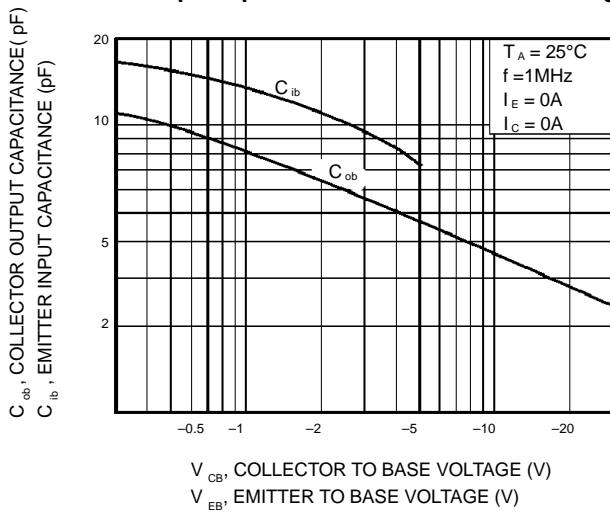
**Fig.7 Collector-emitter saturation voltage vs. collector current (I)**



**Fig.8 Gain bandwidth product vs. emitter current**



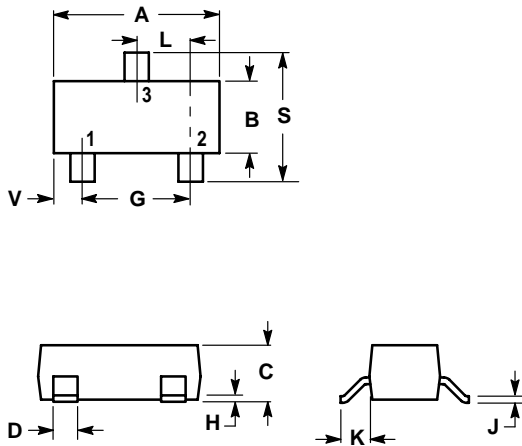
**Fig.9 Collector output capacitance vs. collector-base voltage  
Emitter input capacitance vs. emitter-base voltage**



**SOT-23**

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

